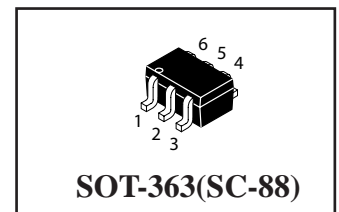
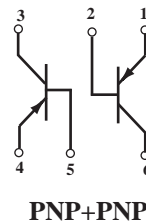


Dual General Purpose Transistor PNP+PNP Silicon

 Lead(Pb)-Free



Maximum Ratings

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	-60	Vdc
Collector-Base Voltage	V _{CBO}	-60	Vdc
Emitter-Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current-Continuous	I _C	-600	mAdc

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Total Device Dissipation TA=25 °C	P _D	225	mW
Thermal Resistance, Junction to Ambient	R _{θJA}	556	°C/W
Junction and Storage, Temperature	T _{J,Tstg}	-55 to +150	°C

Device Marking

MBT2907ADW=2F

Electrical Characteristics (TA=25 °C Unless Otherwise noted)

Characteristics	Symbol	Min	Max	Unit
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Off Characteristics

Collector-Emitter Breakdown Voltage ⁽²⁾ (I _C =-10mAdc, I _B =0)	V(BR)CEO	-60	-	Vdc
Collector-Base Breakdown Voltage (I _C =-10 uAdc, I _E =0)	V(BR)CBO	-60	-	Vdc
Emitter-Base Breakdown Voltage (I _E =10 uAdc, I _C =0)	V(BR)EBO	-5.0	-	Vdc
Base Cutoff Current (V _{CE} =-30 Vdc, V _{EB} =-0.5 Vdc)	I _{BL}	-	-50	nAdc
Collector Cutoff Current (V _{CE} =-30Vdc, V _{EB} =-0.5Vdc)	I _{CEX}	-	-50	nAdc

1. Device Mounted FR4 glass epoxy printed circuit board using the minimum recommended footprint.

2. Pulse Test:Pulse Width≤300uS, Duty Cycle≤2.0%

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristics	Symbol	Min	Max	Unit
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On Characteristics

DC Current Gain ($I_C = -100\mu\text{Adc}, V_{CE} = -10\text{Vdc}$) ($I_C = -1.0\text{ mAdc}, V_{CE} = -10\text{Vdc}$) ($I_C = -10\text{ mAdc}, V_{CE} = -10\text{Vdc}$) ($I_C = -150\text{ mAdc}, V_{CE} = -10\text{Vdc}$) ($I_C = -500\text{ mAdc}, V_{CE} = -10\text{Vdc}$)	H_{FE}	75 100 100 100 50	- - - 300 -	-
Collector-Emitter Saturation Voltage ($I_C = -150\text{ mAdc}, I_B = -15\text{ mAdc}$) ($I_C = -500\text{ mAdc}, I_B = -50\text{ mAdc}$)	$V_{CE(sat)}$	- -	-0.4 -1.6	Vdc
Base-Emitter Saturation Voltage ($I_C = 150\text{ mAdc}, I_B = 15\text{ mAdc}$) ($I_C = 500\text{ mAdc}, I_B = 50\text{ mAdc}$)	$V_{BE(sat)}$	- -	-1.3 -2.6	Vdc

Small-signal Characteristics

Current-Gain-Bandwidth Product ($I_C = -50\text{ mAdc}, V_{CE} = -20\text{ Vdc}, f = 100\text{ MHz}$)	f_T	200	-	MHz
Output Capacitance ($V_{CB} = -10\text{ Vdc}, I_E = 0, f = 1.0\text{ MHz}$)	C_{obo}	-	8.0	pF
Input Capacitance ($V_{EB} = -2.0\text{ Vdc}, I_C = 0, f = 1.0\text{ MHz}$)	C_{ibo}	-	30	pF

Switching Characteristics

Turn-On Time	(Vcc = -30 Vdc, Ic = -150 mAdc, IB1 = -15 mAdc)	t_{off}	-	45	ns
Delay Time		t_d	-	10	
Rise Time		t_r	-	40	
Turn-Off Time		t_{off}	-	100	

TYPICAL CHARACTERISTICS

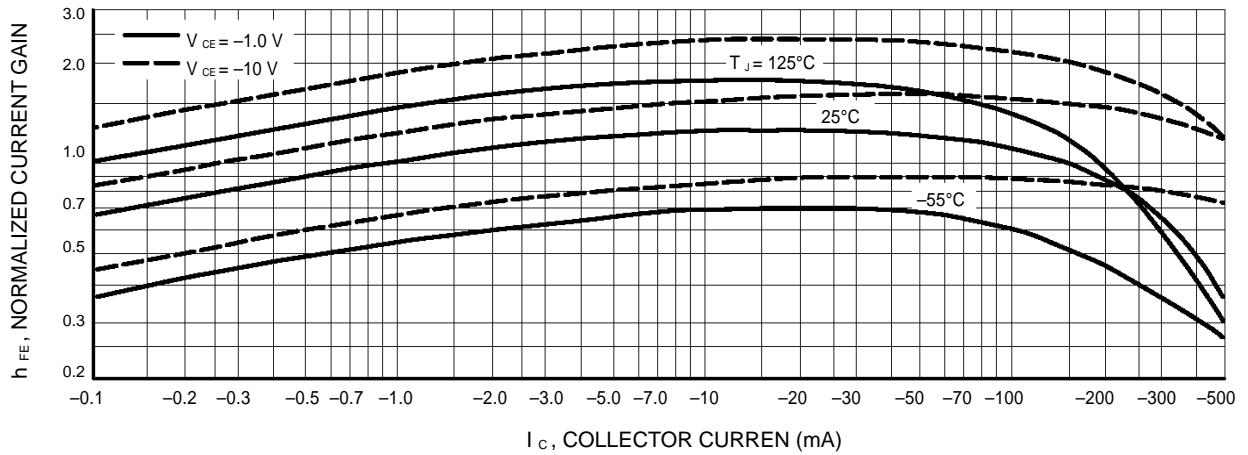


Figure 3. DC Current Gain

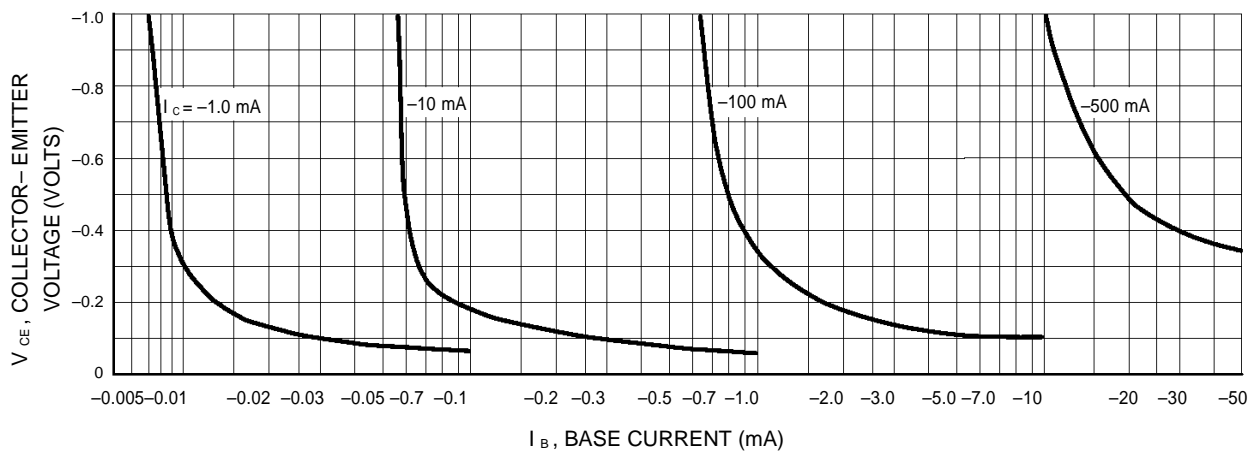


Figure 4. Collector Saturation Region

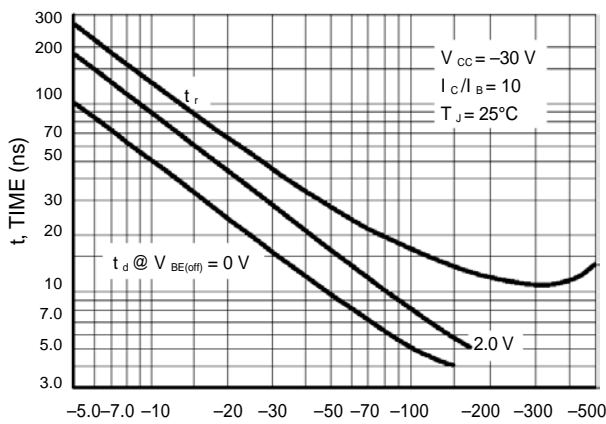


Figure 5. Turn-On Time

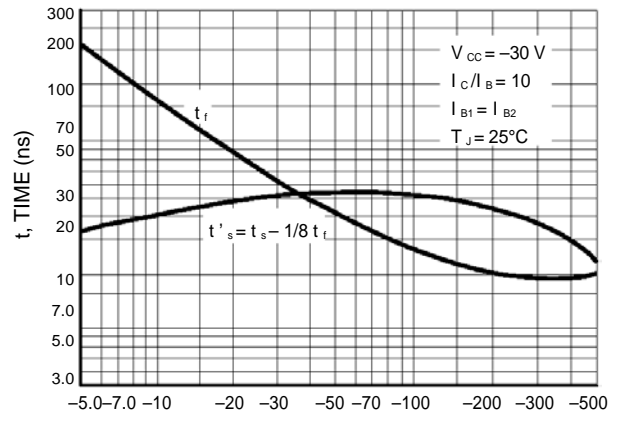


Figure 6. Turn-Off Time

TYPICAL SMALL-SIGNAL CHARACTERISTICS

NOISE FIGURE

$V_{CE} = 10 \text{ Vdc}$, $T_A = 25^\circ\text{C}$

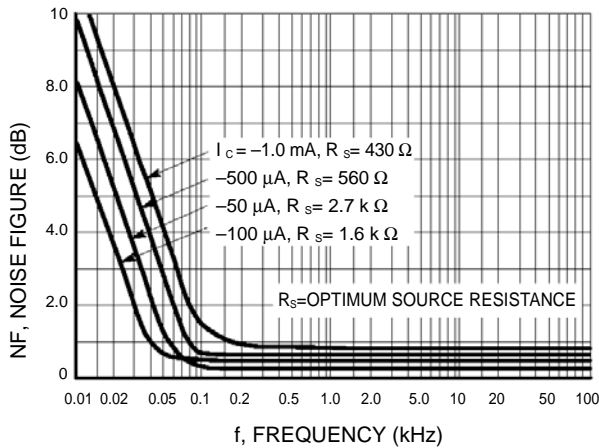


Figure 7. Frequency Effects

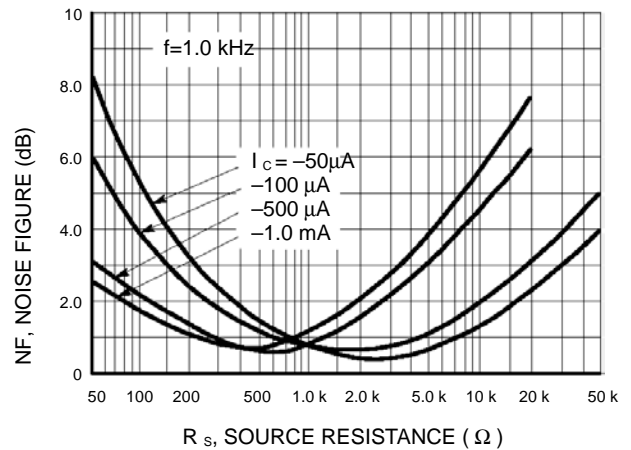


Figure 8. Source Resistance Effects

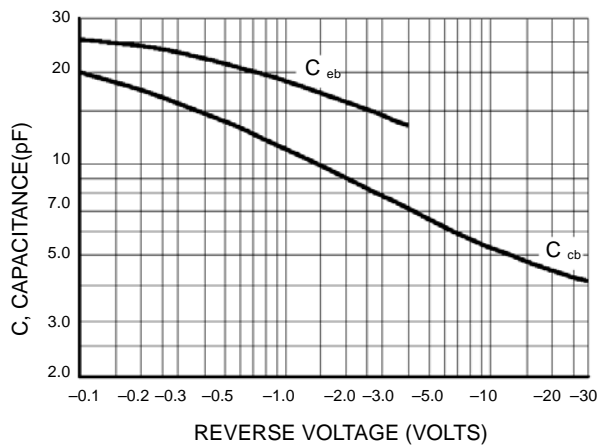


Figure 9. Capacitances

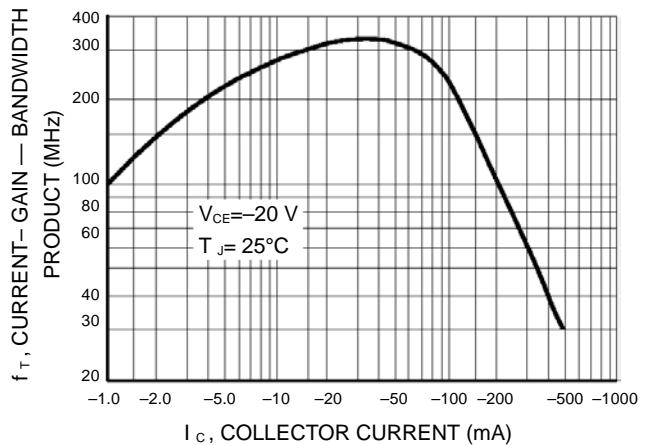


Figure 10. Current-Gain — Bandwidth Product

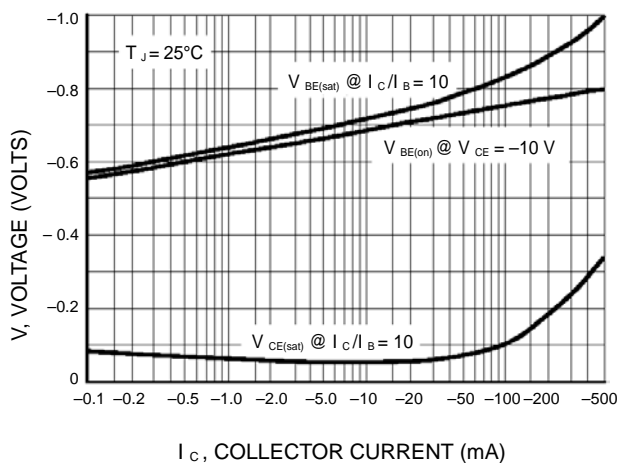


Figure 11. "On" Voltage

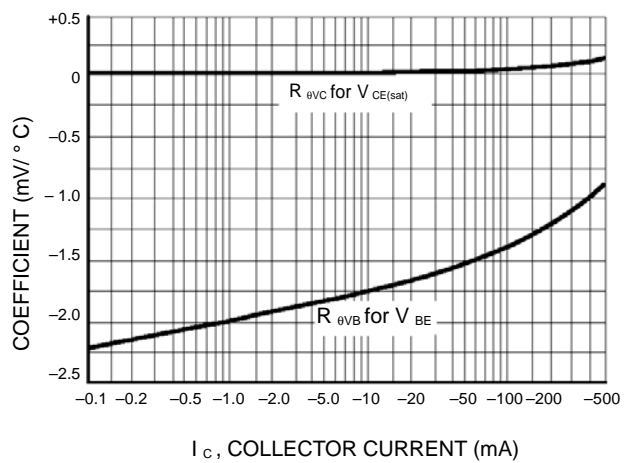
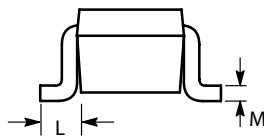
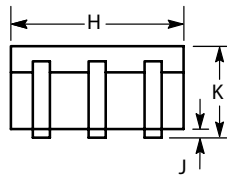
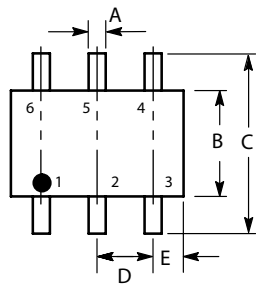


Figure 12. Temperature Coefficients

SOT-363 Package Outline Dimensions

Unit:mm



SOT-363

Dim	Min	Max
A	0.10	0.30
B	1.15	1.35
C	2.00	2.20
D	0.65 REF	
E	0.30	0.40
H	1.80	2.20
J	-	0.10
K	0.80	1.10
L	0.25	0.40
M	0.10	0.25